



Exceptional service in the national interest

SURFACE INSULATION RESISTANCE

In Pursuit of Large Data Sets

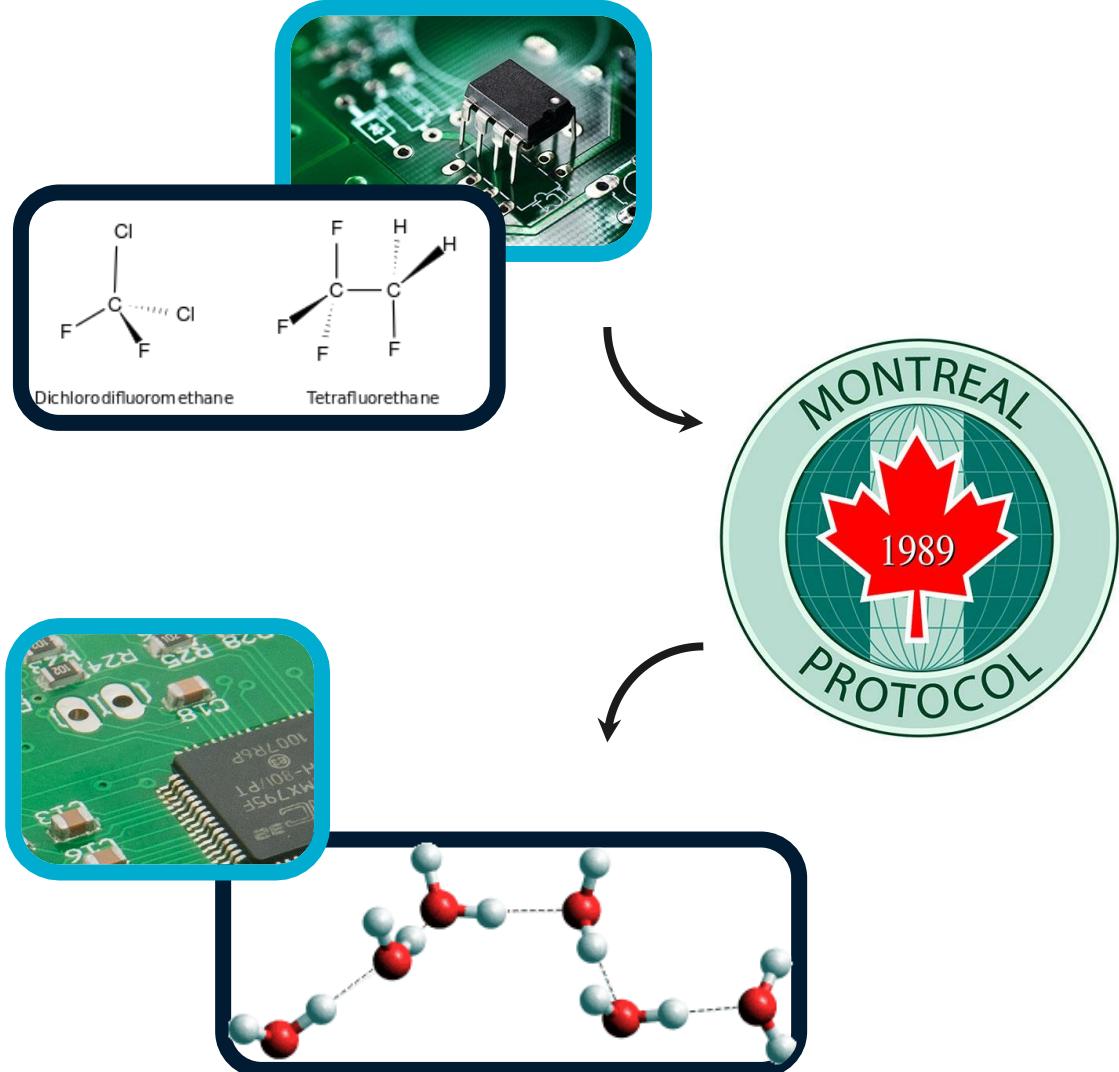
Matthew A. Kottwitz, Jarod Kaltenbaugh,
J. Elliott Fowler

16th World Congress on Computational Mechanics

July 26, 2024
Vancouver, BC, CA



Sandia National Laboratories is a multimission laboratory managed and operated by National Technology and Engineering Solutions of Sandia, LLC, a wholly owned subsidiary of Honeywell International Inc., for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-NA0003525



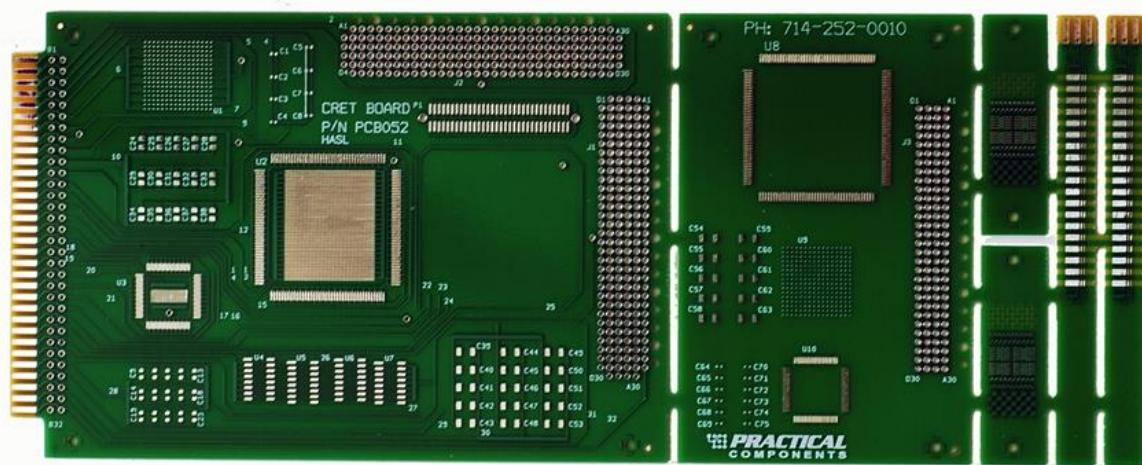
8.1 Qualified Manufacturing Process

...the Manufacturer shall qualify soldering and/or cleaning processes that result in acceptable levels of flux and other residues. Objective evidence shall be available for review...

...This may include

1. *Surface insulation resistance (SIR)*, possibly in combination with ion chromatography...
2. Historical evidence...
3. Electrical testing results... during extremes of temperature and humidity

FROM IPC-B-52 TO SNAP-OFF COUPONS



IPC-B-52

- "...manufactured using the same manufacturing process and surface finish intended for the end-product."
 - Multiple test coupons assembled together (Main, IC, Solder Mask Adhesion, SIR mini,...)

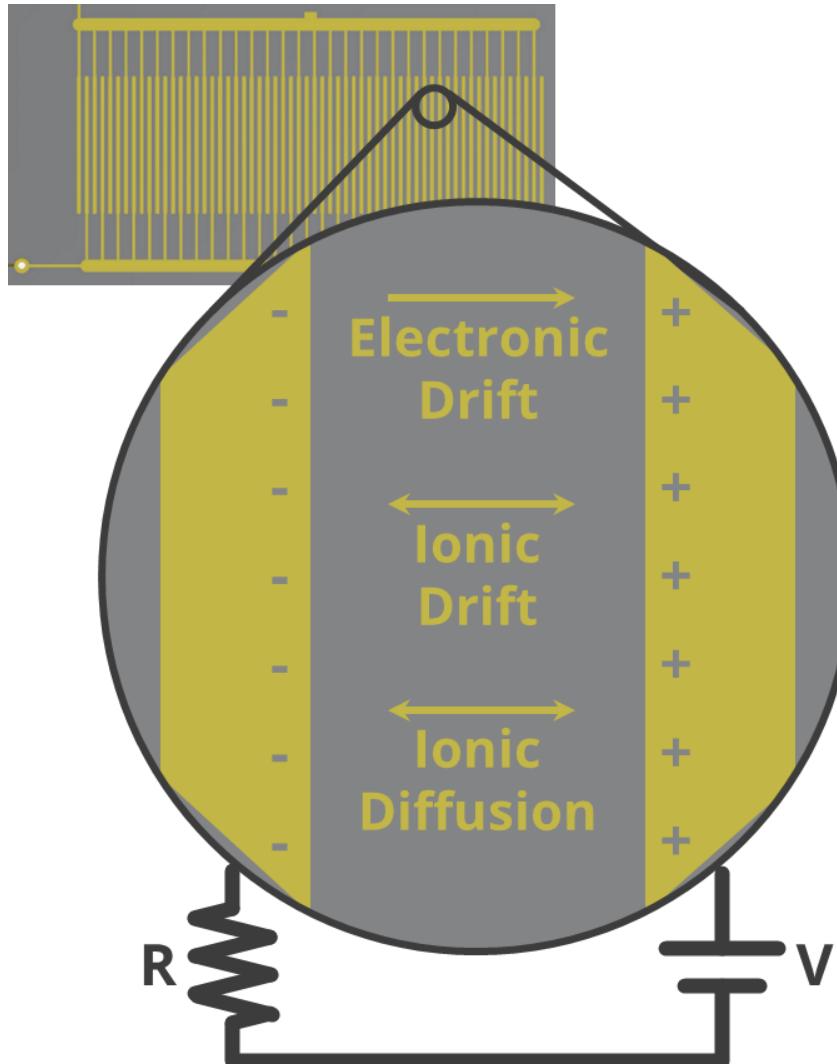
Towards “snap-off” coupons

- Manufactured *concurrently with* the end-product
 - Per panel qualification of cleanliness & reliability

In either case...

- Need for paradigm shift:
Qualitative (Binary) → Quantitative
 - *Mechanistic understanding of SIR*

BASICS OF SIR



- Test cards composed of interdigitated comb (IDC) or other (i.e., BGA, LGA, etc.) patterns
- Elevated temperature/humidity chamber, DC bias (5 V), resistor (1 MΩ)
- Current measured periodically
- Underlying physical phenomena:
Electronic drift
Ionic drift/diffusion
- Affected by:
Pattern design
Materials
Test conditions

SYSTEMATIC EXPLORATION

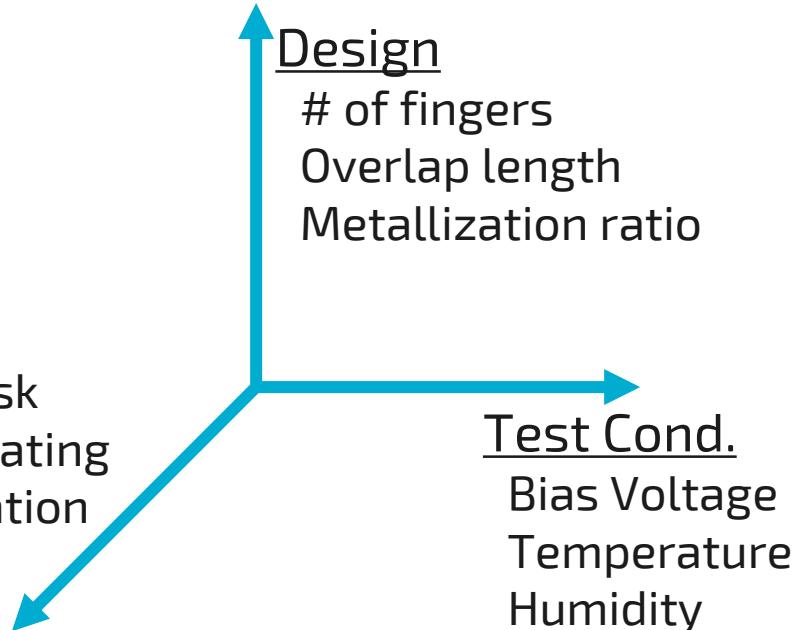


SIR Total Parameter Space

$$I = f(a, b, c, d, e, \dots)$$

Materials

Substrate
Solder mask
Plating/coating
Contamination



Campaigns

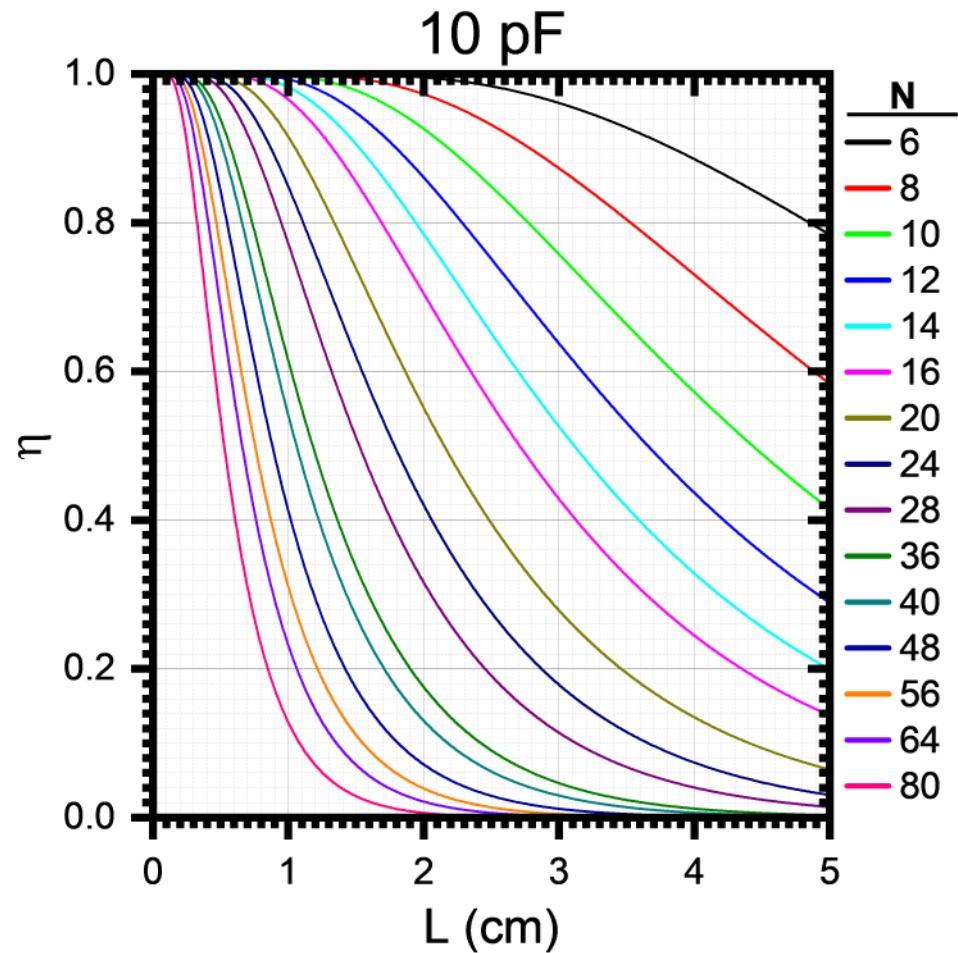
1. Vary design w/ constant capacitance
Clean boards, benign environment
2. Vary design w/ constant capacitance
Clean boards, varied environment
3. Vary design w/ "constant" capacitance
Vary material construction
Vary contamination



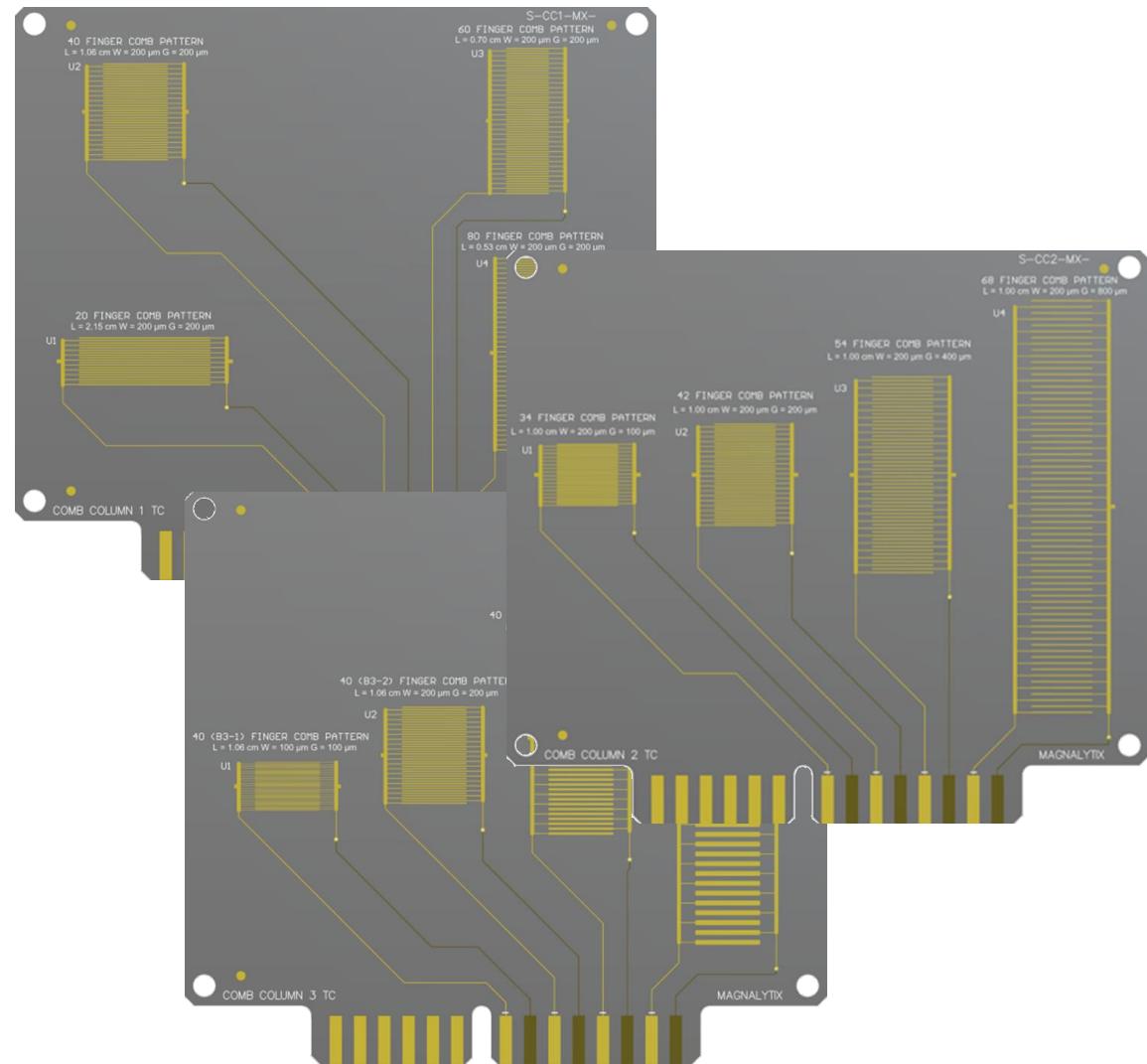
1

CLEAN BOARDS,
BENIGN ENVIRONMENT

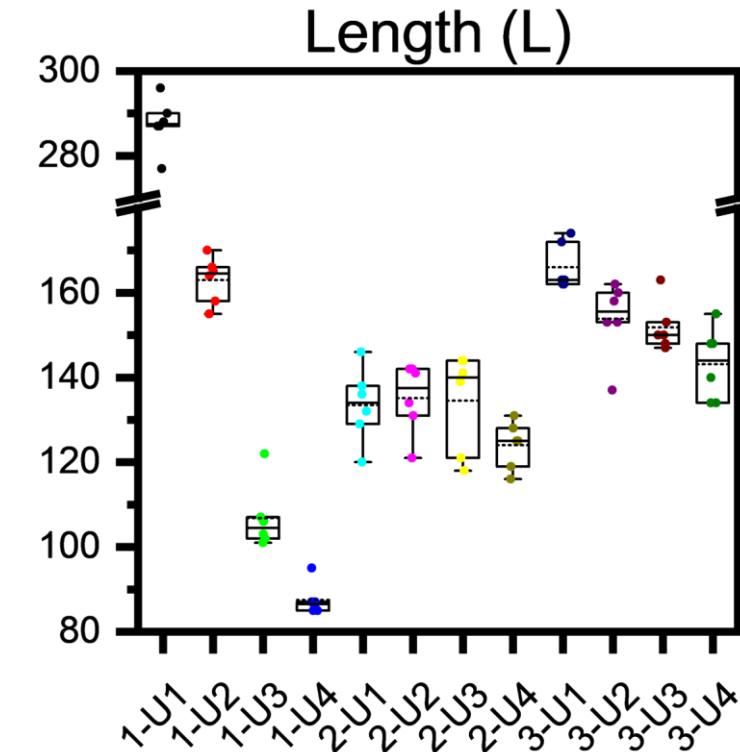
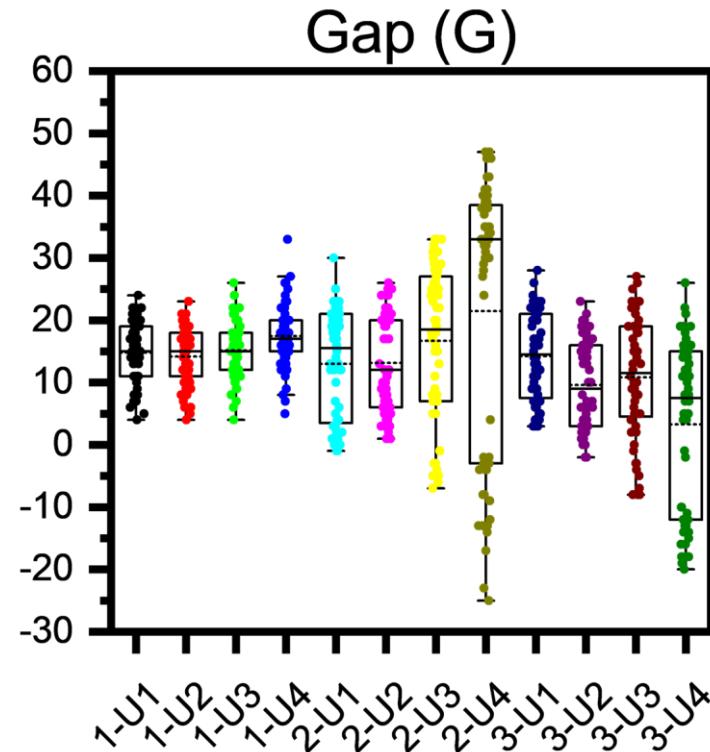
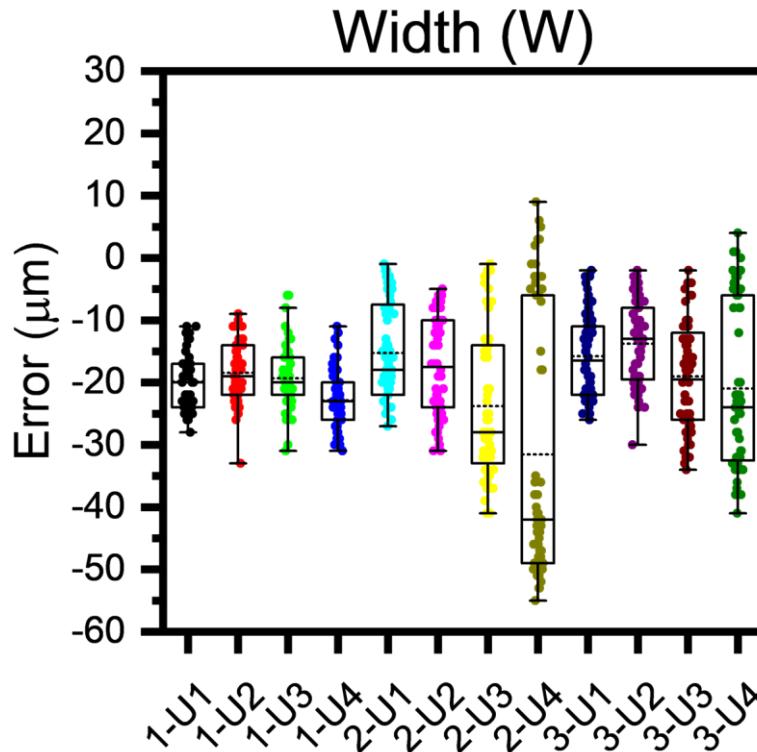
CAPACITANCE COMPUTATION & BOARD DESIGNS



Sensors and Actuators A: Physical 2004, 112, 291

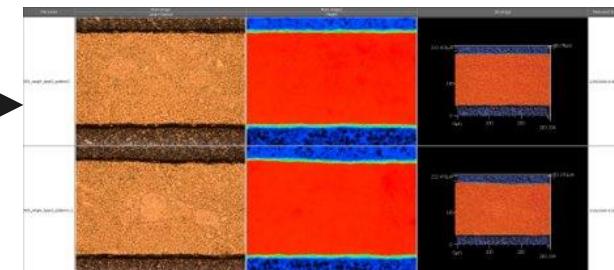


HOW WELL DID THE FAB SHOP DO?

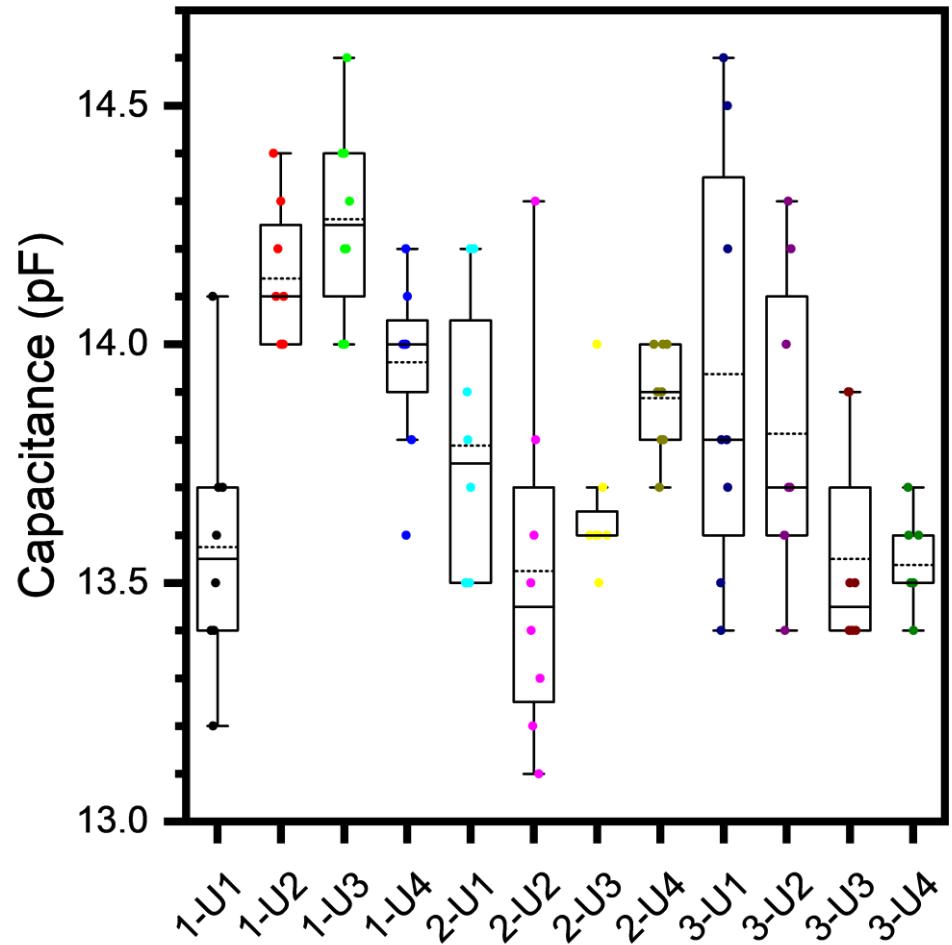


Revision to measurement scheme in progress

- Minimum confocal microscopy for statistical significance
- Incorporate geometry micro-variances into behavior modeling



CAPACITANCE DISCREPANCY



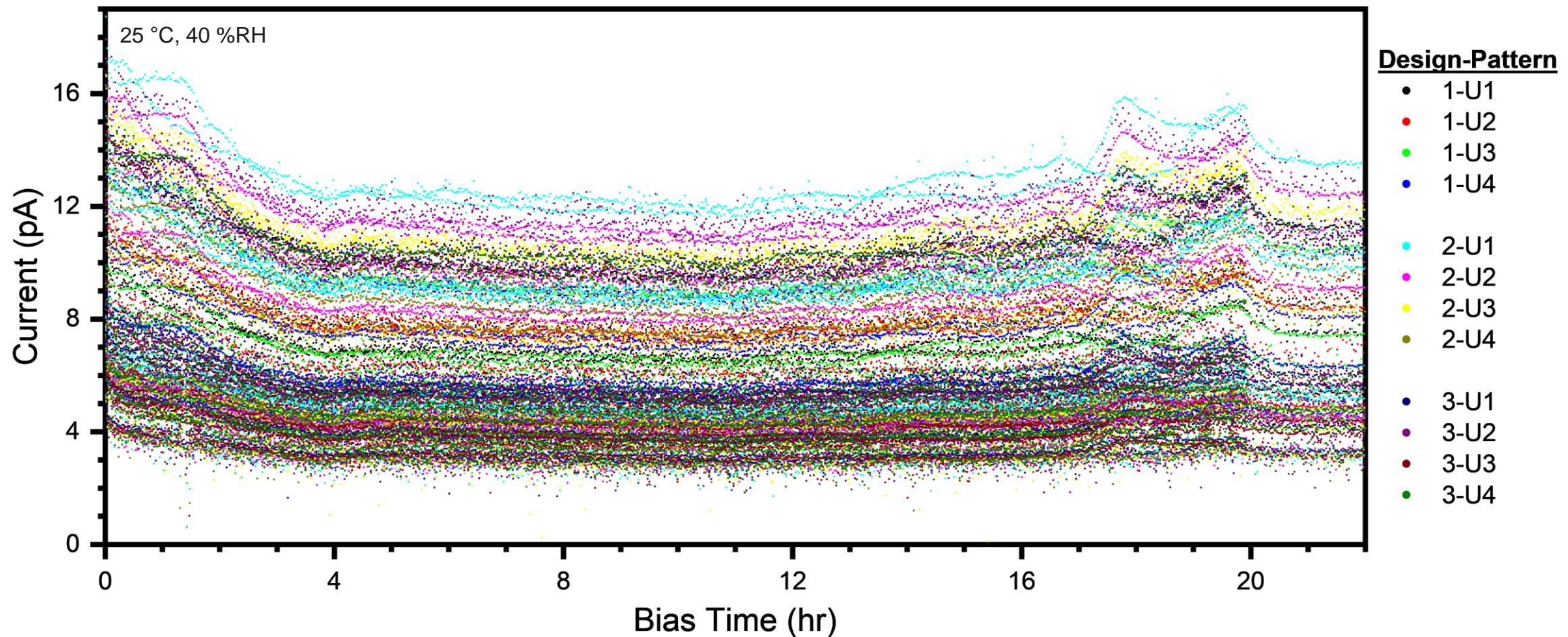
Measured with Agilent E4980A Precision LCR Meter at 1 kHz

Possible causes:

- Single frequency vs sweep measurement
- Room conditions
- Cu traces thicker than model assumption
- FR-4 substrate relative permittivity

Inclusion of solder mask will further increase capacitance

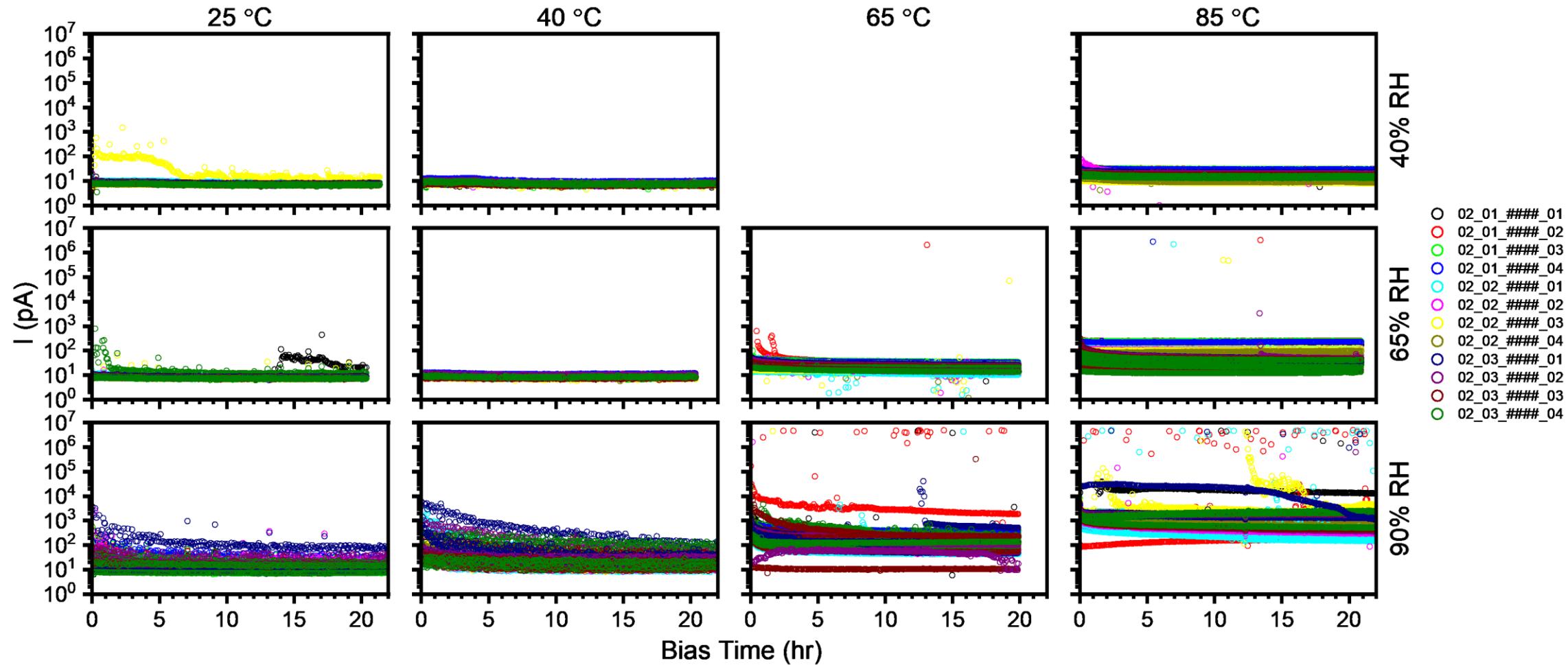
ALL DATA – CAMPAIGN 1



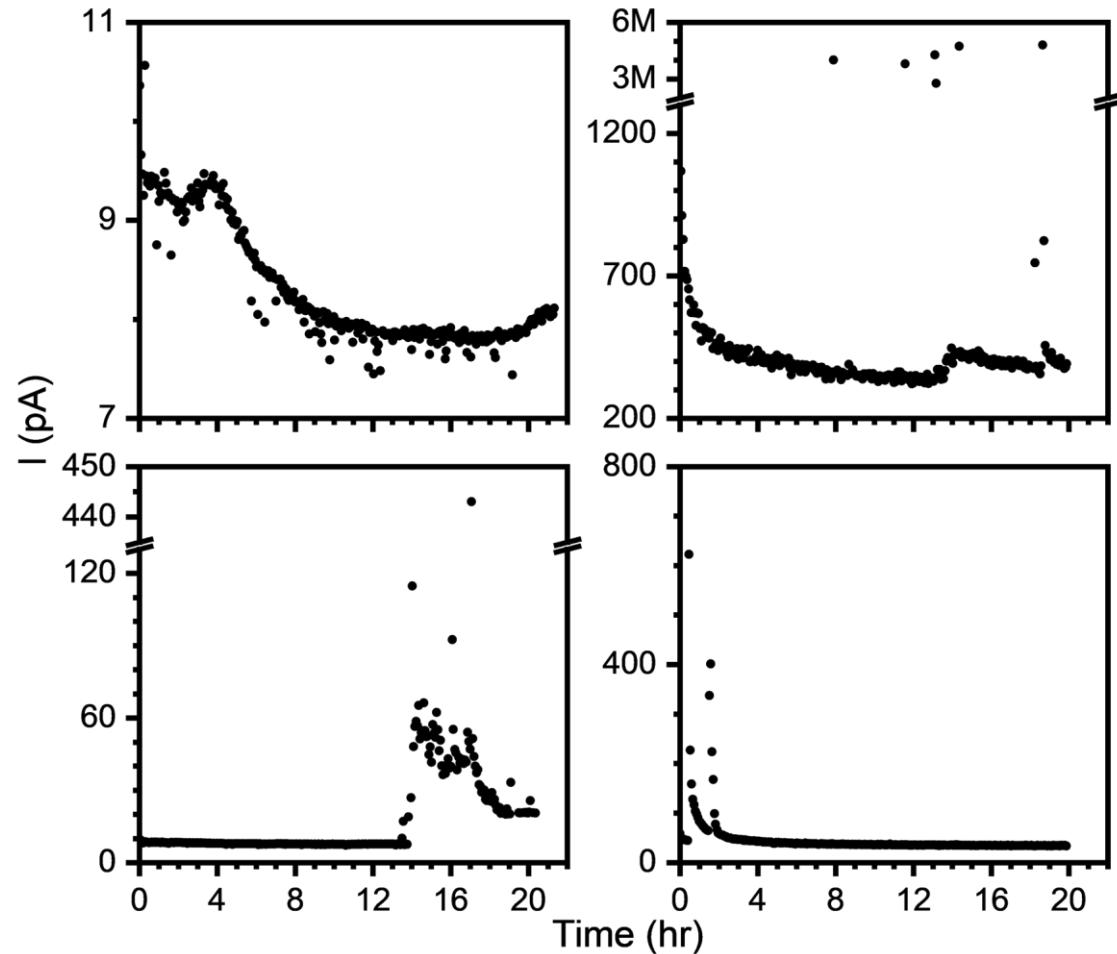
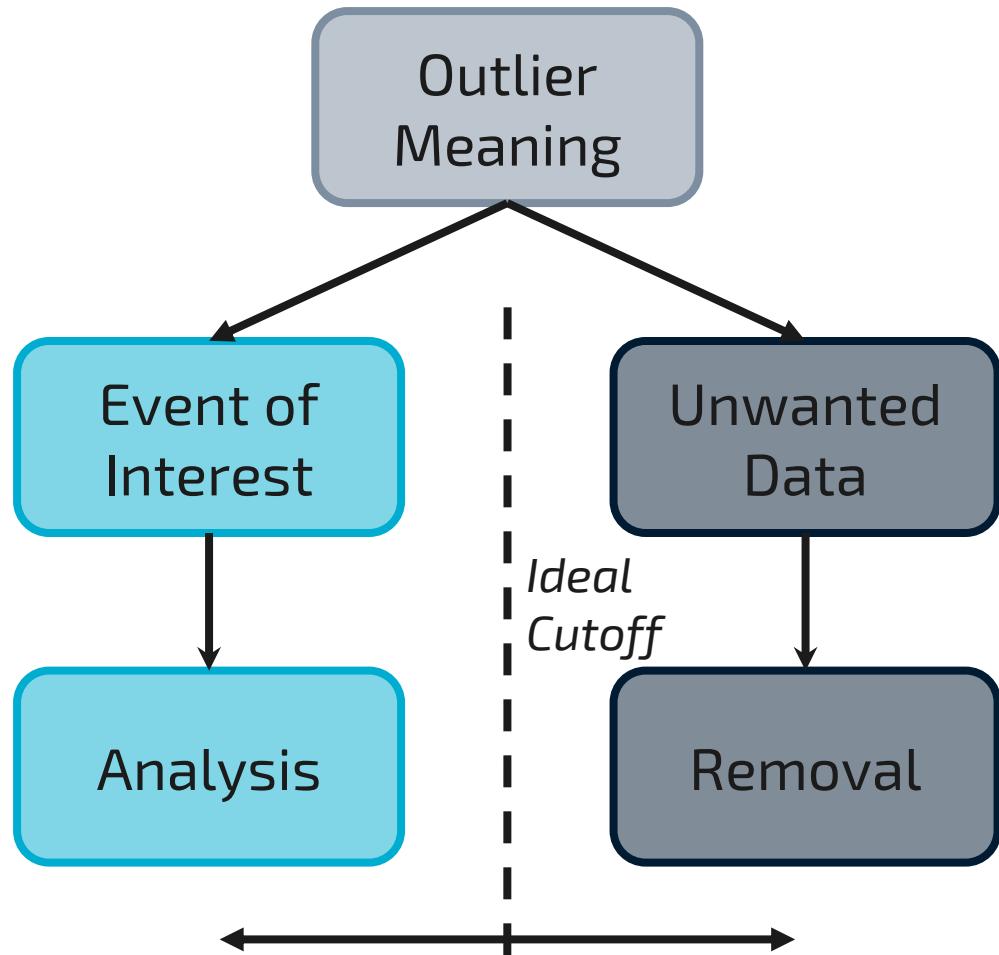


2
CLEAN BOARDS,
VARIED ENVIRONMENT

ALL DATA, RAW – CAMPAIGN 2

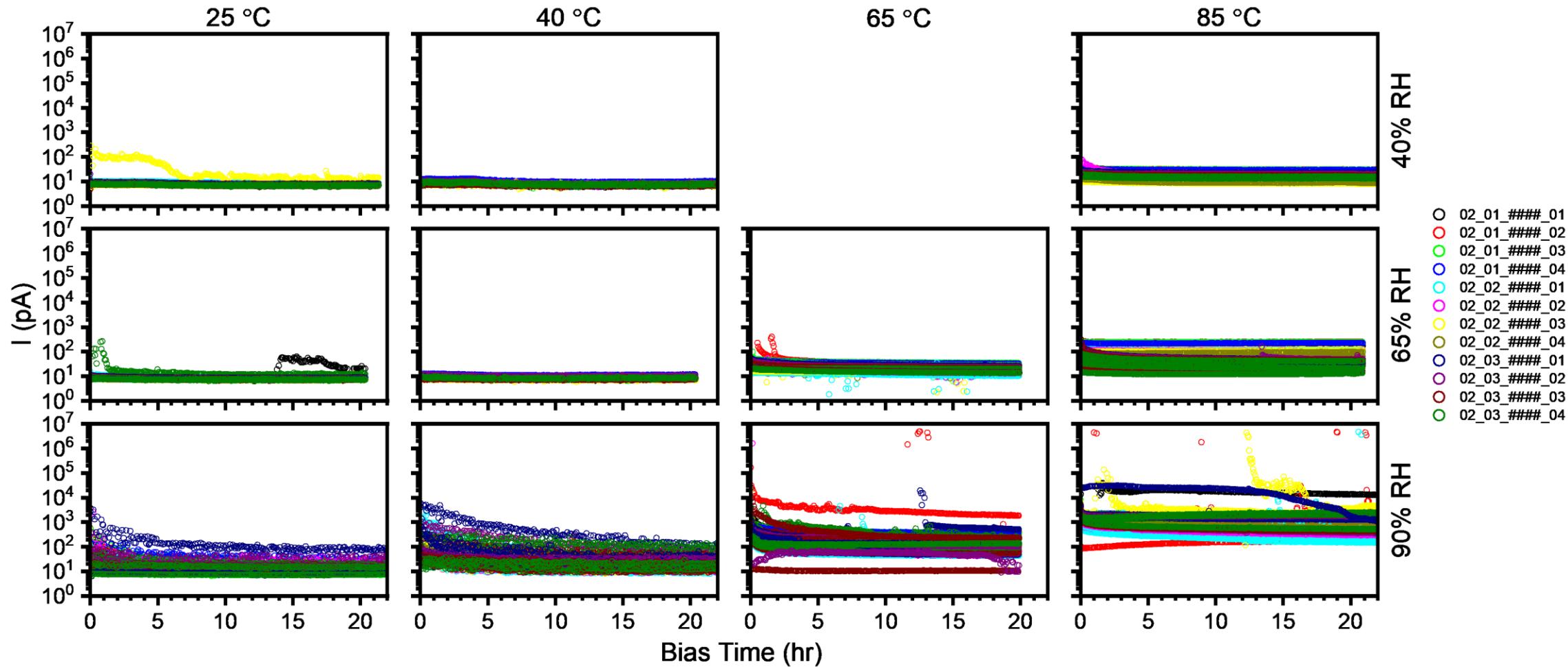


TIME SERIES ANOMALY DETECTION

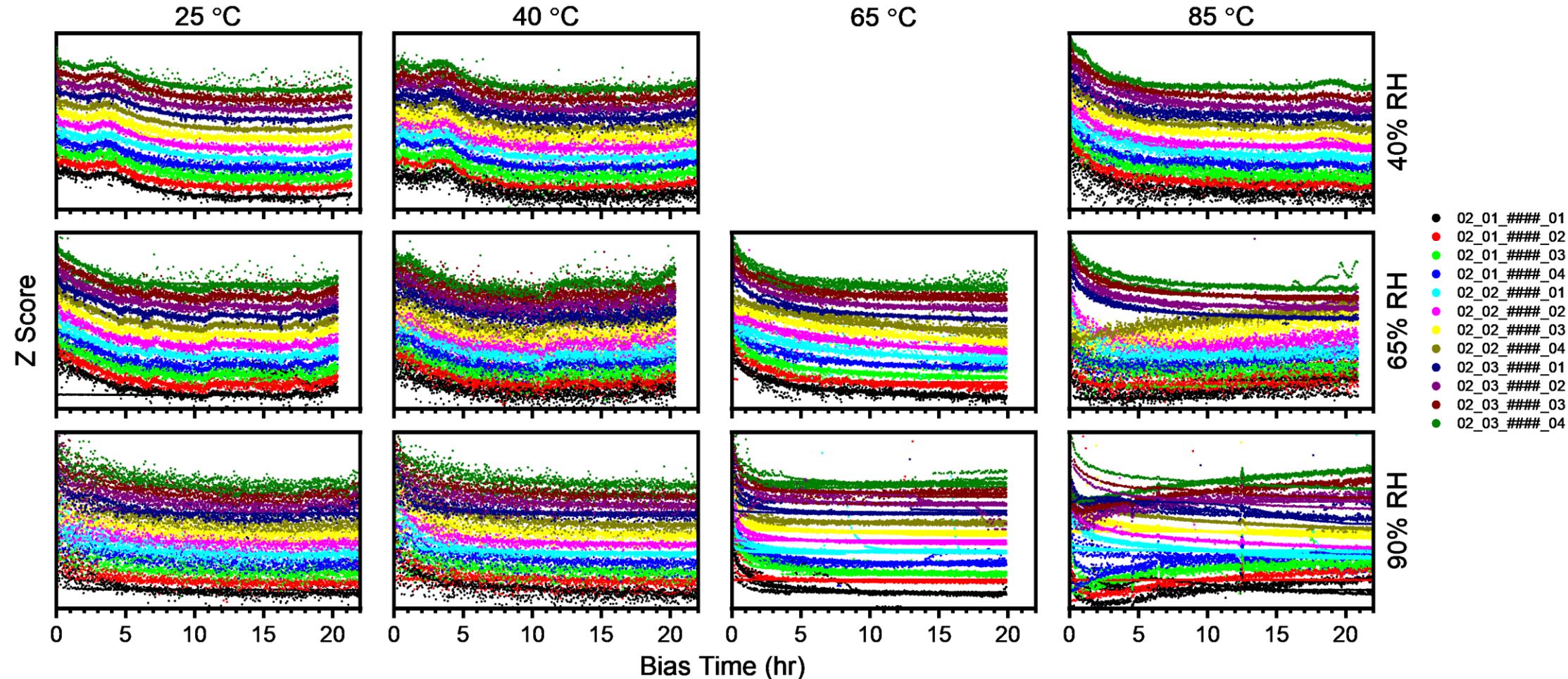


Adapted from neptune.ai/blog/anomaly-detection-in-time-series

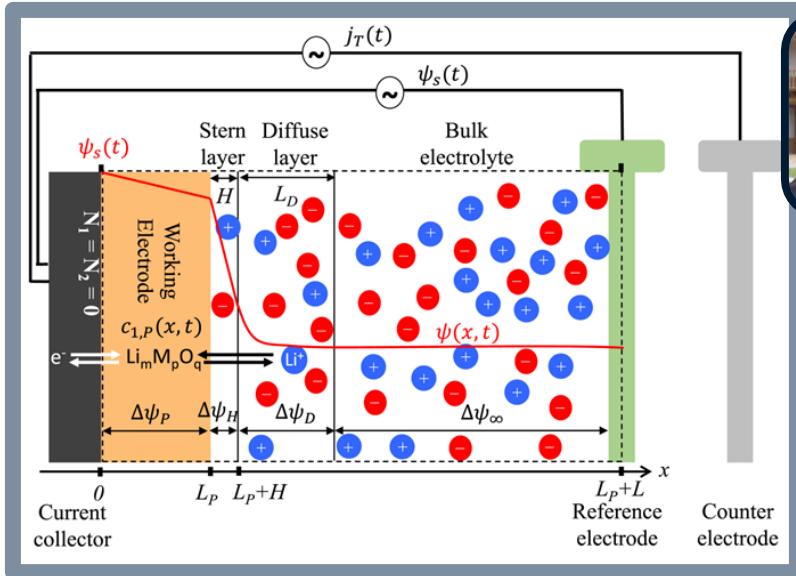
ALL DATA, CLEANED – CAMPAIGN 2



ALL DATA, CLEANED & NORMALIZED – CAMPAIGN 2



MODELING & STATISTICAL ANALYSIS

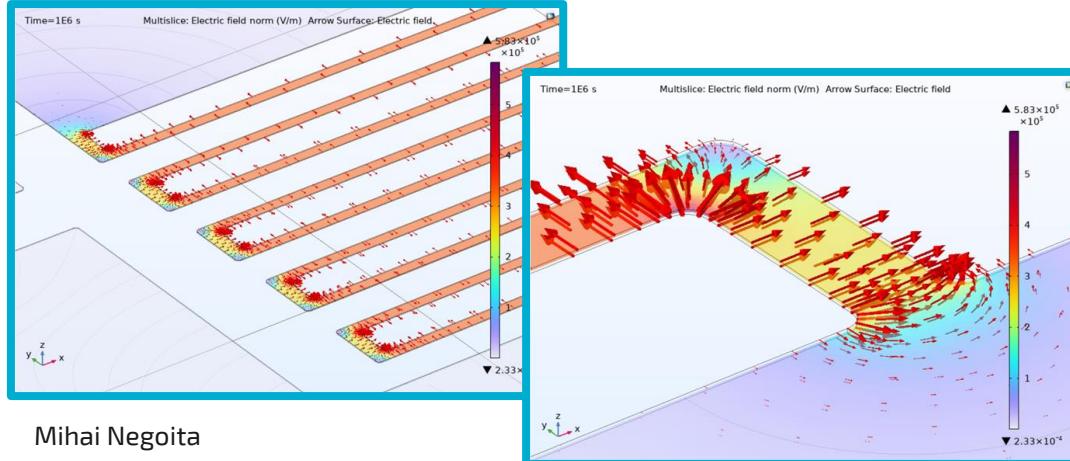


THE UNIVERSITY OF
NEW MEXICO

Sam Gross
(Prof. Fernando Garzon)

$$i = \frac{nF A c_j^0 \sqrt{D_j}}{\sqrt{\pi t}}$$

Electrochimica Acta 2019, 321, 134648



Mihai Negoita

Variable

Importance Score for Predictor to Current

L = 1.06 cm

22.26

L = 2.15 cm

3.08

L = 0.53 cm

18.97

L = 0.7 cm

22.85

G = 200 μ m

13.88

G = 400 μ m

17.57

G = 800 μ m

29.68

W = 200 μ m

11.08

W = 400 μ m

3.42

W = 800 μ m

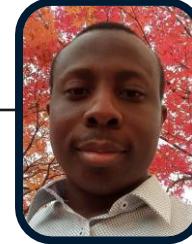
13.79

Temp.

204.61

Rel. Hum.

297.63



Ayorinde Olatunde
(Prof. Anirban Mondal)

Increased with
Contamination?



3
VARIED MATERIALS,
CONTAMINATED BOARDS

CREATING [GOOD] PROBLEMS FOR MYSELF



Design of Experiment

- (only) 2 board designs
- (no) ENIG plating and/or (no) solder mask
- Adipic acid, succinic acid, or commercial flux
x 2 contamination levels (+clean)
- 2 sets of environmental conditions
- 4 chambers across 4 days
- 320 boards x 4 channels
- Before/after EIS (new!)

➤ Approx. 1,500 files or 350,000 data points

A note on contamination

- Mounted spray gun at set distance from horizontal surface, manually actuated
- Tradeoffs vs dip coating & spin coating
- Investigating contamination printing



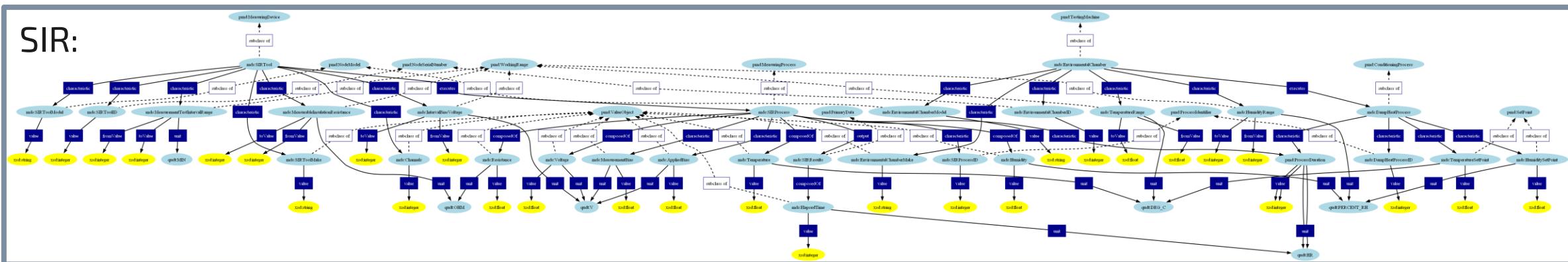
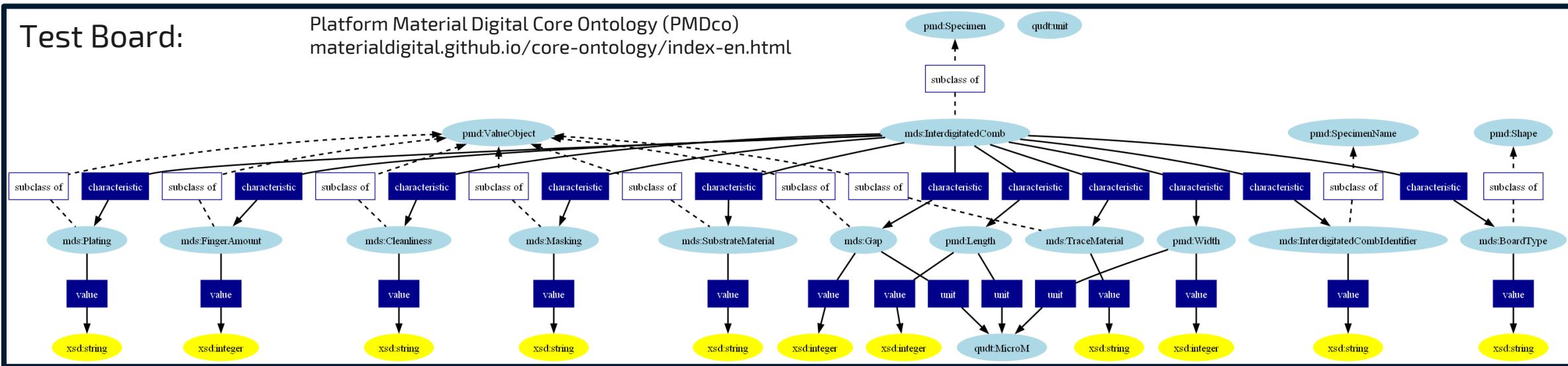
ONTOLOGY DEVELOPMENT



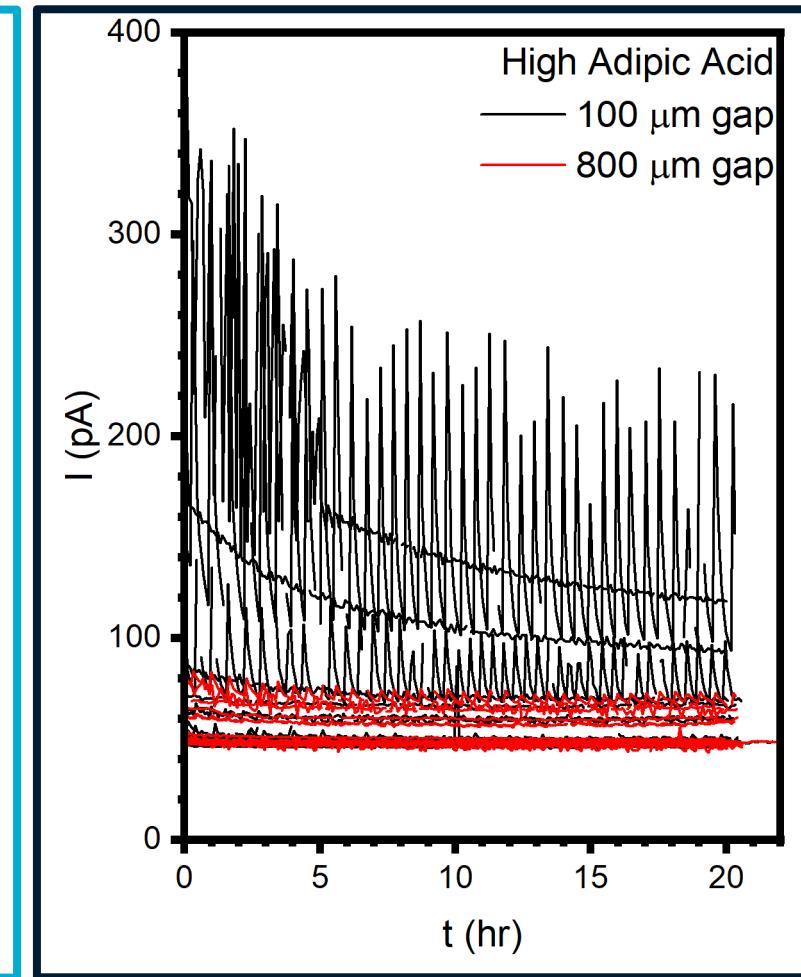
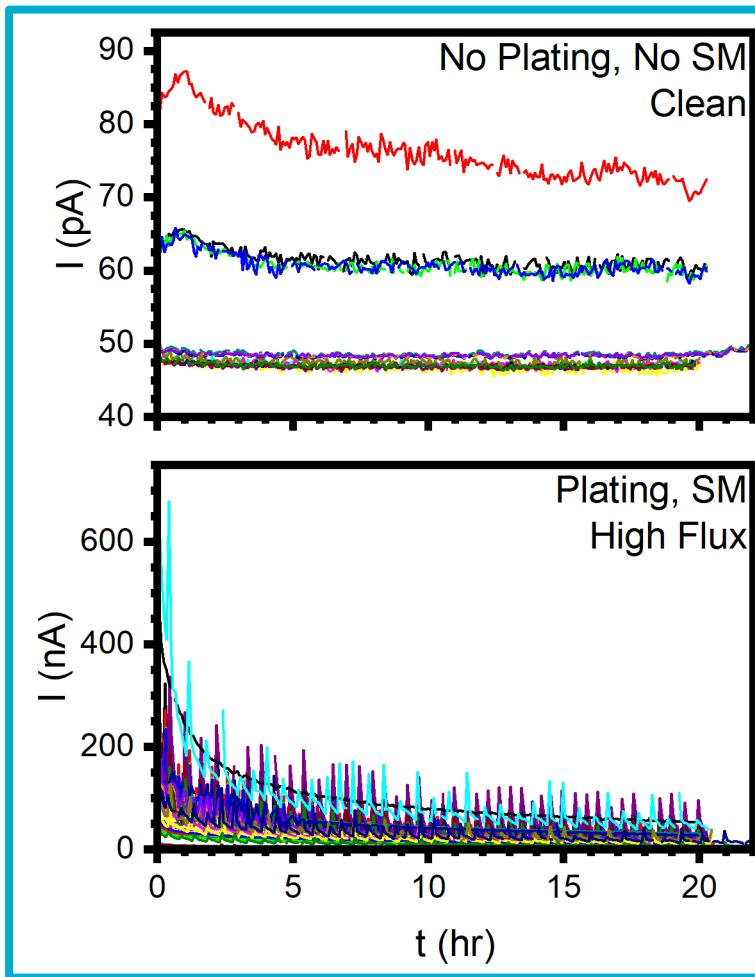
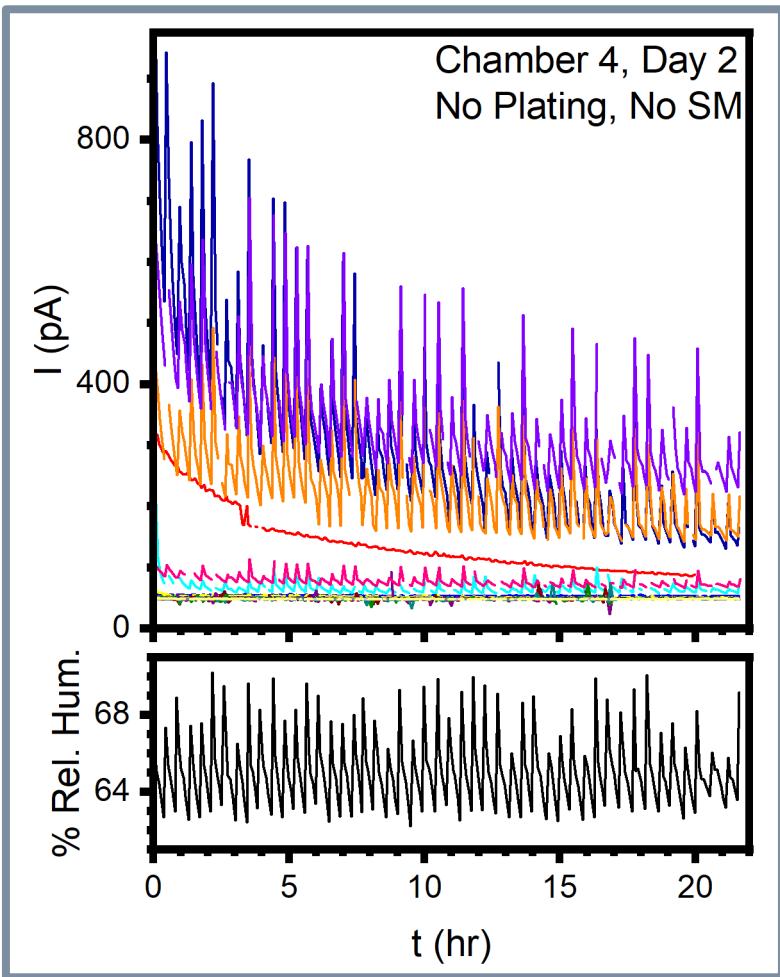
Jarod Kaltenbaugh
(Prof. Kris Davis)

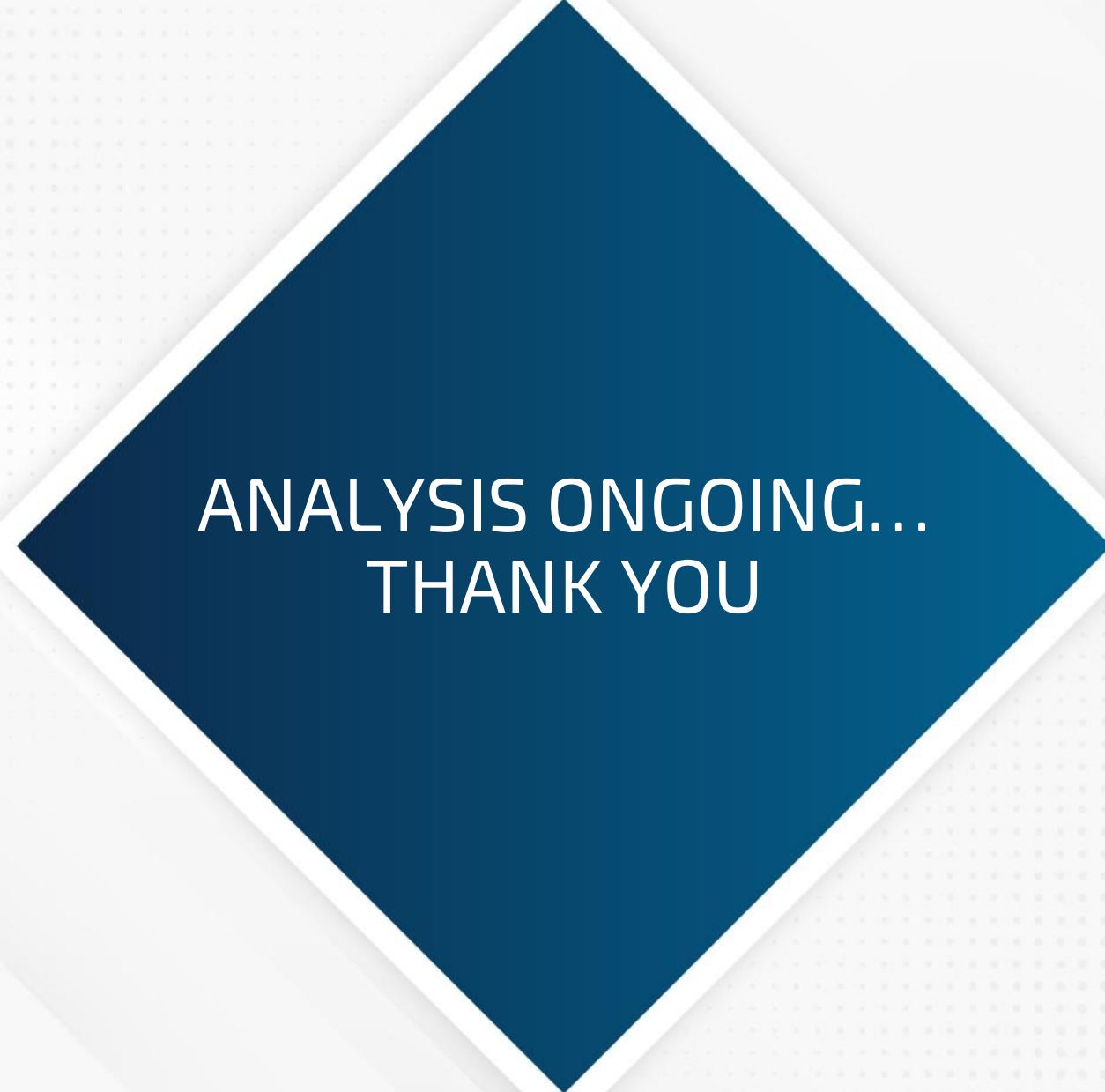


A formal description of knowledge as a set of concepts w/i a domain & the relationships b/w them



LET'S TAKE A PEAK ANYWAY





ANALYSIS ONGOING...
THANK YOU